

Docket No. 195942US0

copy

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Hiroshi IZUI, et al.

SERIAL NO: 09/641,892

GAU: 1636

FILED: August 18, 2000

EXAMINER: Lamberton, D.

FOR: METHOD FOR PRODUCING L-GLUTAMIC ACID BY FERMENTATION ACCOMPANIED BY
PRECIPITATION

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☒ The applicant(s) wish to make of record the reference (D2) cited on the attached European Search Report and listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☐ Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☒ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Electronic Filing System (EFS) Data
Electronic Patent Application Submission
USPTO Use Only

EFS ID: 54325
Application ID: 10680280
Title of Invention: SEMICONDUCTOR PACKAGE AND
METHOD FOR MANUFACTURING
First Named Inventor: Jong Paek
Domestic/Foreign Application: Domestic Application
Filing Date: 2003-10-07
Effective Receipt Date: 2004-01-27
Submission Type: Information Disclosure
Statement
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Confirmation number: 7297
Attorney Docket Number: AMKOR021G




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TRANSMITTAL

Electronic Version v1.1
Stylesheet Version v1.1.0


Title of Invention	SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING									
Application Number: 10/680280 										
Date: 2003-10-07										
First Named Applicant: Jong Sik Paek										
Confirmation Number: 7297										
Attorney Docket Number: AMKOR021G										
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<table border="1"><tr><td>Submitted by:</td><td>Elec. Sign.</td><td>Sign. Capacity</td></tr><tr><td>Mark B. Garred Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Mark B. Garred Registered Number: 34,823	/mbg/	Attorney		
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us-ids	ids1-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

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<p>Application Number: 10/680280 </p> <p>Confirmation Number: 7297</p> <p>First Named Applicant: Jong Paek</p> <p>Attorney Docket Number: AMKOR021G</p> <p>Art Unit: 2811</p> <p>Search string: (2596993 or 3435815 or 3734660 or 3838984 or 4054238 or 4189342 or 4258381 or 4289922 or 4301464 or 4332537 or 4417266 or 4451224 or 4530152 or 4541003 or 4646710 or 4707724 or 4727633 or 4737839 or 4756080 or 4812896 or 4862245 or 4862246 or 4907067 or 4920074 or 4935803 or 4942454 or 4987475 or 5018003 or 5029386 or 5041902 or 5057900 or 5059379 or 5065223 or 5070039 or 5087961 or 5091341 or 5096852 or 5118298 or 5151039 or 5157475 or 5157480 or 5168368 or 5172213 or 5172214 or 5175060 or 5200362 or 5200809 or 5214845 or 5216278 or 5218231 or 20010008305 or 20010014538 or 20010011654 or 20020024122 or 20020027297 or 20020140061 or 20020140068 or 20020163015 or 20030030131 or 20030073265).pn.</p>																																																																							
<h3>US Patent Documents</h3> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>2596993</td><td>1952-05-20</td><td>S.L. GOOKIN</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>3435815</td><td>1969-04-01</td><td>FORCIER</td><td></td><td></td><td></td></tr><tr><td></td><td>3</td><td>3734660</td><td>1973-05-22</td><td>DAVIES ET AL.</td><td></td><td></td><td></td></tr><tr><td></td><td>4</td><td>3838984</td><td>1974-10-01</td><td>CRANE ET AL.</td><td></td><td></td><td></td></tr><tr><td></td><td>5</td><td>4054238</td><td>1977-10-18</td><td>LLOYD ET AL.</td><td></td><td></td><td></td></tr><tr><td></td><td>6</td><td>4189342</td><td>1980-02-19</td><td>KOCK</td><td></td><td></td><td></td></tr><tr><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td></tr></tbody></table>								init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	2596993	1952-05-20	S.L. GOOKIN					2	3435815	1969-04-01	FORCIER					3	3734660	1973-05-22	DAVIES ET AL.					4	3838984	1974-10-01	CRANE ET AL.					5	4054238	1977-10-18	LLOYD ET AL.					6	4189342	1980-02-19	KOCK											
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US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
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	2	20010014538	2001-08-16	KWAN ET AL.			
	3	20010011654	2002-01-31	KIMURA			
	4	20020024122	2002-02-28	JUNG ET AL.			
	5	20020027297	2002-03-07	IKENAGA ET AL.			
	6	20020140061	2002-10-03	LEE			
	7	20020140068	2002-10-03	LEE ET AL.			
	8	20020163015	2002-11-07	LEE ET AL.			
	9	20030030131	2003-02-13	LEE ET AL.			
	10	20030073265	2003-04-17	HU ET AL.			

Signature

Examiner Name	Date